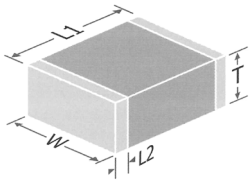
AEC-Q200

MLC Capacitors Qualified to AEC-Q200

AEC-Q200 MLCC Ranges

A range of dc rated multi-layer chip capacitors from 0.5pF to 220nF and in case sizes 0603 to 3640 in C0G/NP0 dielectric. MLC capacitors and surface mount EMI filters qualified to AEC-Q200 rev E. Approved ranges up to a voltage rating of 6kV to meet the requirements of modern automotive applications including EV and HEV. All parts can incorporate either base metal or precious metal electrodes as an option.



Electrical Details		
Capacitance Range		0.5pF to 220nF
Temperature Coefficient of Capacitance (TCC)	C0G/NP0	0 ± 30ppm/°C
Dissipation Factor	C0G/NP0	Cr > 50pF ≤0.0015 Cr ≤ 50pF = 0.0015(15÷Cr+0.7)
	Low Loss	≤ 0.001
Insulation Resistance (IR)		100GΩ or 1000secs (whichever is the less)
Dielectric Withstand Voltage (DWV)		Voltage applied for 5 ±1 seconds, 50mA charging current maximum
Ageing Rate	C0G/NP0	Zero

Range Dimensions – AEC-Q200 MLCC Ranges

Size	Length (L1) mm/inches	Width (W) mm/inches	Max. Thickness (T) mm/inches	Termination Band (L2) mm/inches	
				min	max
0603	1.6 ± 0.15 0.063 ± 0.006	0.8 ± 0.15 0.032 ± 0.006	0.9 0.035	0.20 0.008	0.40 0.016
0805	2.0 ± 0.2 0.079 ± 0.008	1.25 ± 0.2 0.049 ± 0.008	1.3 0.051	0.25 0.010	0.75 0.03
1206	3.2 ± 0.2 0.126 ± 0.008	1.6 ± 0.2 0.063 ± 0.008	1.9 0.075	0.25 0.01	0.75 0.03
1210	3.2 ± 0.2 0.126 ± 0.008	2.5 ± 0.2 0.098 ± 0.008	2.8 0.11	0.25 0.01	0.75 0.03
1210 (VM2)	3.2 + 0.5 / - 0.2 0.126 + 0.02 / - 0.008	2.6 ± 0.3 0.102 ± 0.012	6.0 0.236	0.25 0.01	0.75 0.03
1808	4.5 ± 0.35 0.180 ± 0.014	2.0 ± 0.3 0.08 ± 0.012	2.0 0.08	0.25 0.01	1.0 0.04
1812	4.5 ± 0.30 0.180 ± 0.012	3.2 ± 0.2 0.126 ± 0.008	3.2 0.126	0.25 0.01	1.14 0.045
1825	4.5 ± 0.30 0.180 ± 0.012	6.40 ± 0.4 0.252 ± 0.016	4.0 0.158	0.25 0.01	1.0 0.04
2220*	5.7 ± 0.40 0.225 ± 0.016	5.0 ± 0.4 0.197 ± 0.016	4.0 0.158	0.25 0.01	1.0 0.04
2225*	5.7 ± 0.4 0.225 ± 0.016	6.3 ± 0.4 0.252 ± 0.016	4.0 0.158	0.25 0.01	1.14 0.045
3640	9.2 ± 0.5 0.36 ± 0.02	10.16 ± 0.5 0.4 ± 0.02	4.0 0.158	0.5 0.02	1.5 0.06

Custom chip sizes not included in the table, but larger than 2225, can be considered with minimum tooling charges. Please refer specific requests direct to the sales office.
Max thickness relates to standard components and actual thickness may be considerably less. Thicker parts, or components with reduced maximum thickness, can be considered by request – please refer requests to the sales office.
* Leaded options are available on all options in case sizes 2220 and 2225, please see page 3 for more information.

Ordering Information – AEC-Q200 MLCC Range

1210	Y	100	0103	J	X	T	□□□
Chip Size	**Termination**	**Voltage d.c. (marking code)**	**Capacitance in Pico farads (pF)**	**Capacitance Tolerance**	**Dielectric Codes**	**Packaging**	**Suffix Code**
0603 **0805** **1206** **1210** **1808** **1812** **1825** **2220** **2225** **3640**	**Y** = FlexiCap™ termination base with nickel barrier (100% matte tin plating). RoHS compliant. **H** = FlexiCap™ termination base with nickel barrier (tin/lead plating with min. 10% lead). Not RoHS compliant. **J** = Silver base with nickel barrier (100% matte tin plating). RoHS compliant **A** = Silver base with nickel barrier (tin/lead plating with min. 10% lead). Not RoHS compliant **6** = Nickel Barrier, Sn/Pb Plated Solder (5-20% Lead, non RoHS) **7** = FlexiCap™ Polymer termination, Nickel barrier, Sn/Pb Plated Solder (5-20% Lead, non RoHS)	**010** = 10V **016** = 16V **025** = 25V **050** = 50V **063** = 63V **100** = 100V **200** = 200V **250** = 250V **500** = 500V **630** = 630V **1K0** = 1kV **1K2** =1.2kV **1K5** =1.5kV **2K0** = 2kV **2K5** =2.5kV **3K0** =3kV **4K0** =4kV **5K0** =5kV **6K0** =6kV	<1.0pF Insert a P for the decimal point as the first character. e.g., **P300** = 0.3pF Values in 0.1pF steps ≥1.0pF & <10pF Insert a P for the decimal point as the second character. e.g., **8P20** = 8.2pF Values are E24 series ≥10pF First digit is 0. Second and third digits are significant figures of capacitance code. The fourth digit is the number of zeros following. e.g., **0101** = 100 pF Values are E12 series	**H**: ± 0.05pF (only available for values <4.7pF) <10pF **B**: ± 0.10pF **C**: ± 0.25pF **D**: ± 0.5pF **F**: ± 1.0pF ≥10pF **F**: ± 1% **G**: ± 2% **J**: ± 5% **K**: ± 10% **M**: ± 20%	**K** = C0G/NP0 (1B) **A** = C0G/NP0 (1B/NP0) AEC-Q200	**T** = 178mm (7") reel **R** = 330mm (13") reel **B** = Bulk pack – tubs or trays	Used for specific customer requirements & variants **M01** = Open Mode **T01** = Tandem **E01, E07**= 3 terminal EMI component **E03**=X2Y Integrated pass component **VM2** = Extra thick

* VM2 part only available in selected values see table belpw

Email Europe: KPD-Europe-sales@knowles.com | Asia: KPD-Asia-sales@knowles.com | USA: KPD-NA-sales@knowles.com

AEC-Q200 range – maximum capacitance values

Voltage	Dielectric	0603	0805	1206	1210	1210(VM2)	1808	1812	1825	2220*	2225*	3640
16/25V	Standard	1nF	4.7nF	15nF	33nF	-	27nF	47nF	82nF	100nF	150nF	220nF
50/63V	Standard	1nF	4.7nF	15nF	33nF	-	27nF	47nF	68nF	100nF	150nF	220nF
100V	Standard	680pF	2.2nF	8.2nF	18nF	-	15nF	39nF	47nF	56nF	68nF	180nF
	Low Loss	-	-	10nF	33nF	-	-	-	-	-	-	-
200V	Standard	560pF	1.5nF	3.9nF	8.2nF	-	8.2nF	22nF	33nF	39nF	47nF	100nF
	Low Loss	-	-	10nF	33nF	-	-	33nF	-	-	-	-
250V	Standard	560pF	1.5nF	3.9nF	8.2nF	-	8.2-nF	22nF	33nF	39nF	47nF	100nF
	Low Loss	-	-	10nF	33nF	-	-	33nF	-	-	-	-
500V	Standard	330pF	1.0nF	3.3nF	6.8nF	-	6.8nF	22nF	33nF	39nF	47nF	100nF
	Low Loss	-	-	10nF	33nF	-	-	33nF	-	-	-	-
630V	Standard	-	820pF	2.7nF	6.8nF	-	6.8nF	22nF	33nF	39nF	39nF	100nF
	Low Loss	-	-	10nF	33nF	-	-	33nF	-	-	-	-
1kV	Standard	-	330pF	2.2nF	3.9nF	-	3.9nF	10nF	22nF	22nF	27nF	68nF
	Low Loss	-	-	6.8nF	22nF	39nF to 66nF	-	-	-	-	-	-
1.2kV	Standard	-	180pF	820pF	1.8nF	-	2.2nF	8.2nF	18nF	22nF	27nF	56nF
	Low Loss	-	-	-	12nF	39nF to 66nF	-	-	-	-	-	-
1.5kV	Standard	-	150pF	560pF	1.2nF	-	1.5nF	6.8nF	12nF	15nF	18nF	39nF
2kV	Standard	-	100pF	390pF	560pF	27nF to 44nF	1.0nF	3.3nF	5.6nF	6.8nF	8.2nF	15nF
2.5kV	Standard	-	-	150pF	330pF	-	390pF	1.5nF	3.3nF	3.9nF	4.7nF	8.2nF
3kV	Standard	-	-	100pF	220pF	-	270pF	1.0nF	2.2nF	3.3nF	3.9nF	6.8nF
4kV	Standard	-	-	-	-	-	150pF	680pF	1.5nF	1.8nF	1.8nF	3.3nF
5kV	Standard	-	-	-	-	-	82pF	330pF	560pF	1.0nF	1.2nF	2.2nF
6kV	Standard	-	-	-	-	-	47pF	220pF	270pF	330pF	390pF	1.5nF

*Leaded options are available on all options in case sizes 2220 and 2225, please see page 3 for more information.

3 Terminal EMI Components (Suffix E01) – AEC-Q200 range – maximum capacitance values

Voltage	Dielectric	0805	1206	1806
50V	C0G/NP0	820pF	1.0nF	2.2nF
100V	C0G/NP0	560pF	1.0nF	2.2nF

3 TERMINAL EMI CHIPS (E07) – AEC-Q200 range – maximum capacitance values

Voltage	Dielectric	0805	1206	1806
50V	C0G	220pF	1.0nF	1.5nF
100V	C0G	120pF	560pF	680pF

X2Y Integrated Passive Components (Suffix E03) – AEC-Q200 ranges – min./max. capacitance values

Voltage	Dielectric	0805	1206	1410	1812
50V	C0G/NP0	390pF - 470pF	1.2nF - 1.5nF	4.7nF - 5.6nF	8.2nF - 10nF
100V	C0G/NP0	10pF - 330pF	22pF - 1.0nF	100pF - 3.9nF	820pF - 6.8nF

Note: For some lower capacitance parts, higher voltage parts may be supplied.

Open Mode Range (Suffix M01) AEC-Q200 range – maximum capacitance values

Voltage	Dielectric	0603	0805	1206	1210	1808	1812	2220	2225
16/25V	**C0G/NP0**	220pF	1.0nF	2.2nF	5.6nF	5.6nF	10nF	15nF	18nF
50/63V	**C0G/NP0**	220pF	1.0nF	2.2nF	5.6nF	5.6nF	10nF	15nF	18nF
100V	**C0G/NP0**	220pF	1.0nF	2.2nF	5.6nF	5.6nF	10nF	15nF	18nF
200V	**C0G/NP0**	150pF	680pF	1.8nF	3.9nF	3.9nF	10nF	15nF	18nF
250V	**C0G/NP0**	150pF	680pF	1.8nF	3.9nF	3.9nF	10nF	15nF	18nF
500V	**C0G/NP0**	-	470pF	1.0nF	2.2nF	2.2nF	5.6nF	15nF	18nF
630V	**C0G/NP0**	-	220pF	560pF	1.8nF	1.8nF	5.6nF	15nF	18nF
1kV	**C0G/NP0**	-	47pF	220pF	470pF	470pF	1.0nF	2.7nF	3.3nF

Surge Protection and Safety Range – AEC-Q200 range – min./max. capacitance values

Dielectric	Approval Body	Y2/X1 SYX/UYX				
		1808	**1812**	**2211**	**2215**	**2220**
COG	**TÜV, UL**	5.6pF-220pF	5.6pF-820pF	4.7pF-1nF	820pF-1.0nF	-

Dielectric	Approval Body	Y2/X1 SYS/UYS		X2 S2X/U2X	
		1808	**1812**	**1808**	**1812**
COG	**TÜV, UL**	5.6pF-220pF	5.6pF-680pF	10pF-1.0nF	10pF-1.5nF

Safety Certified Capacitors - AEC-Q200 ranges

Chip size	Classification		Knowles Family Code	Dielectric	Cap Range	Approval specification	Approval Body
1808	Y2 (250Vac) + X1 (305Vac)	FOWX2 + FOWX8	SYX	C0G	5.6pF – 220pF	IEC/EN60384-14:2013 +A1:2016 UL/CAN/CSA60384-14:2014	TÜV UL
1812	Y2 (250Vac) + X1 (305Vac)	FOWX2 + FOWX8	SYX	C0G	5.6pF – 820pF	IEC/EN60384-14:2013 +A1:2016 UL/CAN/CSA60384-14:2014	TÜV UL
2211	Y2 (250Vac) + X1 (305Vac)	FOWX2 + FOWX8	SYX	C0G	4.7pF – 1nF	IEC/EN60384-14:2013 +A1:2016 UL/CAN/CSA60384-14:2014	TÜV UL
2215	Y2 (250Vac) + X1 (305Vac)	FOWX2 + FOWX8	SYX	C0G	820pF – 1nF	IEC/EN60384-14:2013 +A1:2016 UL/CAN/CSA60384-14:2014	TÜV UL
1808	Y2 (250Vac) + X1 (305Vac)	FOWX2 + FOWX8	SYS	C0G	5.6pF – 220pF	IEC/EN60384-14:2013 +A1:2016 UL/CAN/CSA60384-14:2014	TÜV UL
1808	X2 (250Vac)	FOWX2 + FOWX8	S2X	C0G	10pF - 1.0nF	IEC/EN60384-14:2013 +A1:2016 UL/CAN/CSA60384-14:2014	TÜV UL
1812	X2 (250Vac)	FOWX2 + FOWX8	S2X	C0G	10pF – 2.2nF	IEC/EN60384-14:2013 +A1:2016 UL/CAN/CSA60384-14:2014	TÜV UL

Ordering Information – AEC-Q200 Safety Certified Capacitors

SYX/UYX/SYM/UYM family

1808	J	A25	0102	K	K	T	SYX
Chip Size	**Termination**	**Rated Voltage**	**Capacitance in Pico farads (pF)**	**Capacitance Tolerance**	**Dielectric Codes**	**Packaging**	**Suffix code**
1808 **1812** **2211** **2215** **2220**	**J** = nickel barrier (Tin). RoHS compliant. **Y** = FlexiCap™ termination base with Ni barrier (100% matte tin plating). RoHS compliant.	**A25** = 250Vac	First digit is 0. Second and third digits are significant figures of capacitance code. The fourth digit is number of zeros following. Example: **0102** = 1.0nF	<10pF **B** = ±0.10pF **C** = ±0.25pF **D** = ±0.50pF ≥ 10pF **F** = ±1% **G** = ±2% **J** = ±5% **K** = ±10% **M** = ±20%	**K** = C0G/NP0 (1B) to AEC-Q200	**T** = 178mm (7") reel **R** = 330mm (13") reel **B** = Bulk pack – tubs or trays	**SYX =** Y2 (250Vac) / X1 (305Vac) Marked + Approved **UYX =** Unmarked parts in accordance with above but not certified

S2X/U2X family

1808	J	A25	0102	J	G	T	S2X
Chip Size	**Termination**	**Rated Voltage**	**Capacitance in Pico farads (pF)**	**Capacitance Tolerance**	**Dielectric Codes**	**Packaging**	**Suffix code**
1808 **1812**	**J** = nickel barrier (Tin). RoHS compliant. **Y** = FlexiCap™ termination base with Ni barrier (100% matte tin plating). RoHS compliant.	**A25** = 250Vac	First digit is 0. Second and third digits are significant figures of capacitance code. The fourth digit is number of zeros following. Example: **0562** = 5.6nF	<10pF **B** = ±0.10pF **C** = ±0.25pF **D** = ±0.50pF ≥ 10pF **F** = ±1% **G** = ±2% **J** = ±5% **K** = ±10% **M** = ±20%	**G** = C0G/NP0 **K** = C0G/NP0 (1B) to AEC-Q200	**T** = 178mm (7") reel **R** = 330mm (13") reel **B** = Bulk pack – tubs or trays	**S2X =** X2 (250Vac) Marked + Approved **U2X =** Unmarked parts in accordance with above but not certified

Performance and Testing

	C0G/NP0/X8G		
	Ultra stable		
IECQ-CECC	1B/CG	-	-
EIA	-	C0G/NP0	-
MIL	-	-	CG (BP)
Rated temperature range	-55ºC to +125ºC		
Rated temperature range (DR1/WR2/WR3)	-		
Maximum capacitance change over temperature range	0 ± 30 ppm/ºC		
Rated DC voltage applied			
Knowles / Syfer dielectric ordering code	C		
Tangent of loss angle (tan δ)	Cr > 50pF ≤ 0.0015 Cr ≤ 50pF = 0.0015(15÷Cr+0.7) Low Loss ≤ 0.001		
Insulation resistance (Ri) OR Time constant (Ri*Cr) (whichever is the least)	100G Ω or 1000s		
Capacitance tolerance (ordering code)	Cr <4.7pF	± 0.05pF (H) ± 0.10pF (B) ± 0.25pF (C) ± 0.50pF (D)	
	Cr <10pF	± 0.10pF (B) ± 0.25pF (C) ± 0.50pF (D)	
	Cr ≥10pF	± 1% (F) ± 2% (G) ± 5% (J) ± 10% (K)	
Dielectric strength	Voltage applied for 5 seconds max. Charging current limited to 50mA maximum.		
<200V **>200V to <500V** **500V to <1000V** **>1kV to <1200V** **>1000V** **>1200V**	2.5 times Rated voltage + 250V 1.5 times 1.25 times - 1.2 times		
Climatic category (IEC)			
Chip	55/125/56		
Ageing characteristic (Typical)	Zero		

Soldering Information

Knowles MLCCs are compatible with all recognised soldering/mounting methods for chip capacitors. A detailed application note is available at syfer.com

Reflow Soldering

Knowles recommend reflow soldering as the preferred method for mounting MLCCs. Knowles MLCCs can be reflow soldered using a reflow profile generally defined in IPC/FEDEC J-STD-020. Sn plated termination chip capacitors are compatible with both conventional and lead free soldering with peak temperatures of 260 to 270°C acceptable.

The heating ramp rate should be such that components see a temperature rise of 1.5 to 4°C per second to maintain temperature uniformity through the MLCC.

The time for which the solder is molten should be maintained at a minimum, so as to prevent solder leaching. Extended times above 230°C can cause problems with oxidation of Sn plating. Use of an inert atmosphere can help if this problem is encountered. Palladium/Silver (Pd/Ag) terminations can be particularly susceptible to leaching with free lead, tin rich solders and trials are recommended for this combination.

Cooling to ambient temperature should be allowed to occur naturally, particularly if larger chip sizes are being soldered. Natural cooling allows a gradual relaxation of thermal mismatch stresses in the solder joints. Forced cooling should be avoided as this can induce thermal breakage.

Wave Soldering

Wave soldering is generally acceptable, but the thermal stresses caused by the wave have been shown to lead to potential problems with larger or thicker chips. Particular care should be taken when soldering SM chips larger than size 1210 and with a thickness greater than 1.0mm for this reason.

Maximum permissible wave temperature is 270°C for SM chips.

The total immersion time in solder should be kept to a minimum. It is strongly recommended that Sn/Ni plated terminations are specified for wave soldering applications.

Solder Leaching

Leaching is the term for the dissolution of silver into the solder causing a failure of the termination system which causes increased ESR, tan δ and open circuit faults, including ultimately the possibility of the chip becoming detached.

Leaching occurs more readily with higher temperature solders and solders with a high tin content. Pb free solders can be very prone to leaching certain termination systems. To prevent leaching, exercise care when choosing solder allows and minimize both maximum temperature and dwell time with the molten solder.

Plated terminations with nickel or copper anti-leaching barrier layers are available in a range of top coat finishes to prevent leaching occurring. These finishes also include Knowles FlexiCap™ for improved stress resistance post soldering.

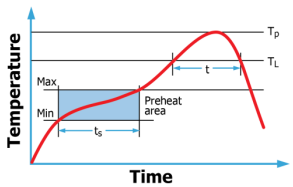
Reflow Soldering for Leaded Parts

Reflow solder in accordance with IPC-A-610. Recommended reflow profile as laid down in IPC/JEDEC J-STD-020.

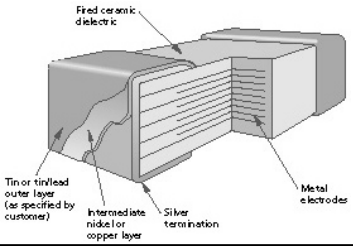
Wave soldering not possible for Tab leaded stand-offparts.

Peak re-flow temperature (Tp) 250ºC. Solder volume should be calculated such that the meniscus between tab and board remains under the 'cut-out' guidance edge on the tab (see diagram). Excessive solder or heat may reflow the solder between the lead and MLCC, impacting the integrity of the joint

Hand soldering of Tab leaded parts is not recommended.



Multilayer ceramic chip with nickel or copper barrier termination



Rework of Chip Capacitors

Knowles recommend hot air/gas as the preferred method of applying heat for rework. Apply even heat surrounding the component to minimise internal thermal gradients. Soldering irons or other techniques that apply direct heat to the chip or surrounding area should not be used as these can result in micro cracks being generated.

Minimise the rework heat duration and allow components to cool naturally after soldering.

Use of Silver Loaded Epoxy Adhesives

Chip capacitors can be mounted to circuit boards using silver loaded adhesive provided the termination material of the capacitor is selected to be compatible with the adhesive. This is normally PdAg. Standard tin finishes are often not recommended for use with silver loaded epoxies as there can be electrical and mechanical issues with the joint integrity due to material mismatch.

Handling & Storage

Components should never be handled with fingers; perspiration and skin oils can inhibit solderability and will aggravate cleaning.

Chip capacitors should never be handled with metallic instruments. Metal tweezers should never be used as these can chip the product and leave abraded metal tracks on the product surface. Plastic or plastic coated metal types are readily available and recommended – these should be used with an absolute minimum of applied pressure.

Incorrect storage can lead to problems for the user. Rapid tarnishing of the terminations, with an associated degradation of solderability, will occur if the product comes into contact with industrial gases such as sulphur dioxide and chlorine. Storage in free air, particularly moist or polluted air, can result in termination oxidation.

Packaging should not be opened until the MLCs are required for use. If opened, the pack should be re-sealed as soon as practicable. Alternatively, the contents could be kept in a sealed container with an environmental control agent.

Long term storage conditions, ideally, should be temperature controlled between -5 and +40°C and humidity controlled between 40% and 60% R.H.

Taped product should be stored out of direct sunlight, which might promote deterioration in tape or adhesive performance.

Product, stored under the conditions recommended above, in its "as received" packaging, has a minimum shelf life of 2 years.

SM Pad Design

Knowles conventional 2-terminal chip capacitors can generally be mounted using pad designs in accordance with IPC-7351, Generic Requirements for Surface Mount Design and Land Pattern Standards, but there are some other factors that have been shown to reduce mechanical stress, such as reducing the pad width to less than the chip width. In addition, the position of the chip on the board should also be considered.

3-terminal components are not specifically covered by IPC-7351, but recommended pad dimensions are included in the Knowles catalogue/website for these components.

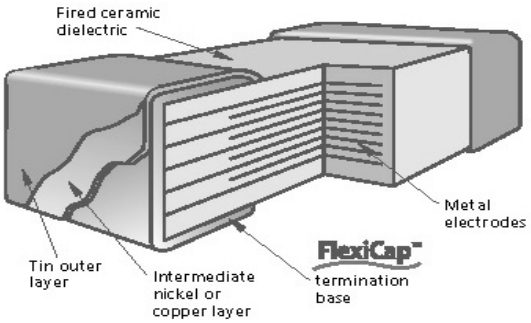
FlexiCap™ Termination

FlexiCap™ has been developed as a result of listening to customer's experiences of stress damage to MLCCs fom many manufacturers, often caused by variations in production processes.

Our answer is a proprietary flexible epoxy polymer termination material, that is applied to the device under the usual nickel barrier finish. FlexiCap™ will accommodate a greater degree of boardbending than conventional capacitors.

All ranges are available with FlexiCap™ termination material offering increased reliability and superior mechanical performance (board flex and temperature cycling) when compared with standard termination materials. Refer to Knowles application note reference AN0001. FlexiCap™ capacitors enable the board to be bent almost twice as much as before mechanical cracking occurs. Refer to application note AN0002.

FlexiCap™ is also suitable for space applications having passed thermal vacuum outgassing tests. Refer to Knowles application note reference AN0026.



FlexiCap™ MLCC cross section

Knowles has delivered millions of FlexiCap™ components and during that time has collected substantial test and reliability data, working in partnership with customers world wide, to eliminate mechanical cracking.

An additional benefit of FlexiCap™ is that MLCCs can withstand temperature cycling from -55° to 125°C in excess of 1,000 times without cracking.

FlexiCap™ termination has no adverse effect on any electrical parameters, nor affects the operation of the MLCC in any way.

Application Notes

FlexiCap™ may be handled, stored and transported in the same manner as standard terminated capacitors. The requirements for mounting and soldering FlexiCap™ are the same as for standard SMD capacitors.

For customers currently using standard terminated capacitors there should be no requirement to change the assembly process when converting to FlexiCap™.

Based upon the board bend tests in accordance with IEC 60384-1 the amount of board bending required to mechanically crack a FlexiCap™ terminated capacitor is significantly increased compared with standard terminated capacitors.

Product: C0G	Typical bend performance under AEC-Q200 test conditions
Standard Termination	2mm to 3mm
FlexiCap™	Typically 8mm to 10mm

REACH (Registration, Evaluation, Authorisation and restriction of Chemicals) Statement

The main purpose of REACH is to improve the protection of human health and the environment from the risks arising from the use of chemicals.

Knowles monitors the REACH legislation to ensure compliance. All products made by Knowles are 'articles' under the definition of REACH and a certificate of compliance is maintained on our website www.knowlescapacitors.com/syfer.

For further information, please contact the sales office at SyferSales@knowles.com

---

RoHS Compliance

Knowles routinely monitors world wide material restrictions (e.g., EU/China and Korea RoHS mandates) and is actively involved in shaping future legislation.

All standard C0G/NPO, X7R, X5R and High Q Knowles MLCC products are compliant with the EU RoHS directive (see below for special exemptions) and those with plated terminations are suitable for soldering common lead free solder alloys (refer to 'Soldering Information' for more details on soldering limitations). Compliance with EU RoHS directive automatically signifies compliance with some other legislation (e.g., Korea RoHS). Please refer to the Sales Office for details of compliance with other materials legislation.

Breakdown of material content, SGS analysis reports and tin whisker test results are available on request.

Most Knowles MLCC components are available with non-RoHS compliant tin/lead (SnPb) Solderable termination finish for exempt applications and where pure tin is not acceptable. Other tin free termination finishes may also be available – please refer to the Sales Office for further details.

X8R ranges <250Vdc are not RoHS 2011/65/EU compliant.

Check the website, www.knowlescapacitors.com/syfer for latest RoHS update.

Export Controls and Dual-use Regulations

Certain Knowles catalogue components are defined as 'dual-use' items under international export controls – those that can be used for civil and military purposes which meet certain specified technical standards.

The defining criteria for a dual-use component with respect to Knowles products is one with a voltage rating of >750V and a capacitance value >250nF and a series inductance <10nH.

Components defined as 'dual-use' under the above criteria automatically require a licence for export outside the EU, and may require a licence for export with the EU.

The application for a licence is routine, but customers for these products will be asked to supply further information.

Please refer to the sales office if you require any further information on export restrictions.

Other special components may additionally need to comply with export regulations.

Ageing of Ceramic Capacitors

Capacitor ageing is a term used to describe the negative, logarithmic capacitance change which takes place in ceramic capacitors with time. The crystalline structure for barium titanate based ceramics changes on passing through its Curie temperature (known as the Curie Point) at about 125ºC. The domain structure relaxes with time and in doing so, the dielectric constant reduces logarithmically; this is known as the ageing mechanism of the dielectric constant. The more stable dielectrics have the lowest ageing rates.

The ageing process is reversible and repeatable. Whenever the capacitor is heated to a temperature above the Curie Point the ageing process starts again fromzero.

The ageing constant, or ageing rate, is defined as the percentage loss of capacitance due to the ageing process of the dielectric which occurs during a decade of time (a tenfold increase in age) and is expressed as percent per logarithmic decade of hours. As the law of decrease of capacitance is logarithmic, this means that a capacitor with an ageing rate of 1% per decade of time, the capacitance will decrease at a rate of:

a) 1% between 1 and 10 hours

b) An additional 1% between the following 10 and 100 hours

c) An additional 1% between the following 100 and 1000 hours

d) An additional 1% between the following 1000 and 10000 hours

e) The ageing rate continues in this manner throughout the capacitor's life.

Typical values of the ageing constant for our MLCCs are

Dielectric Class	Typical Values
Ultra Stable C0G/NP0	Negligible capacitance loss through ageing

Capacitance Measurements

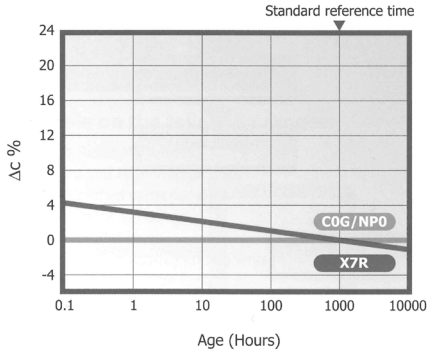
Because of ageing it is necessary to specify an age for reference measurements at which the capacitance shall be within the prescribed tolerance. This is fixed at 1000 hours, since for all practical purposes there is not much further loss of capacitance after this time.

All capacitors shipped are within their specified tolerance at the standard reference age of 1000 hours after having cooled through their Curie temperature.

The ageing curve for any ceramic dielectric is a straight line when plotted on semi-log paper.

Capacitance vs Time

(Ageing X7R @ 1% per decade)



Tight Tolerance

One of the advantages of Knowles's unique 'wet process' of manufacture is the ability to offer capacitors with exceptionally tight capacitance tolerances.

The accuracy of the printing screens used in the fully automated, computer controlled manufacturing process allows for tolerance as close as ± 1% on C0G/NP0 parts greater than or equal to 10pF. For capacitance value less than 4.7pF tolerances can be as tight as ± 0.05pF.

Periodic Tests Conducted and Reliability Data

For standard surface mount capacitors components are randomly selected on a sample basis and the following routine tests conducted:

- Load Test. 1,000 hours @ 125ºC (150oOC for X8R). Applied voltage depends on components tested
- Humidity Test. 168 hours @ 85ºC/85%RH
- Board Deflection (bend test)

Test results are available on request.

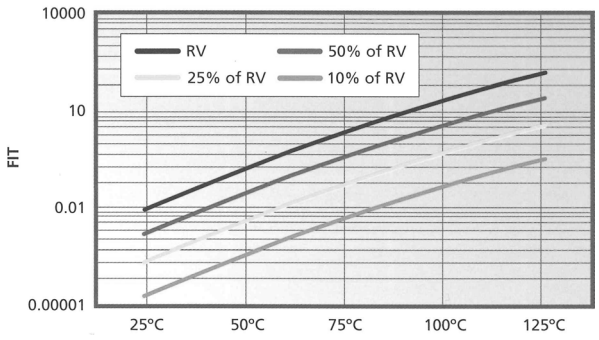
Conversion Factors

From	To	Operation
FITs	MTBF (hours)	$10^9 \div$ FITs
FITs	MTBF (years)	$10^9 \div$ (FITs × 8760)

FIT = Failures In Time. 1 FIT = 1 failure in 10^9 hours

MTBF = Mean Time Between Failure

Example of FIT Data Available

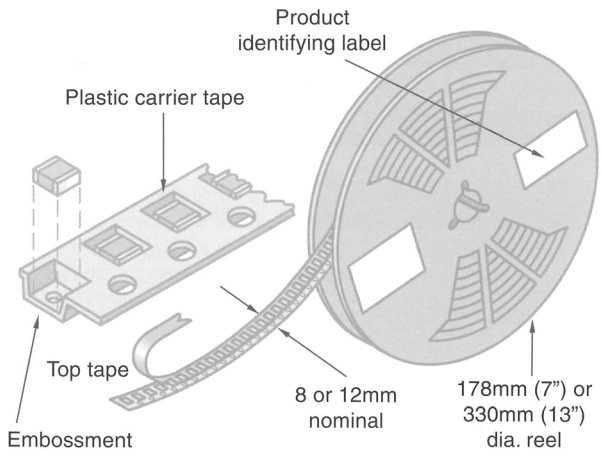


Component type:	0805 (C0G/NP0 and X7R)
Testing Location:	Knowles reliability test department
Results based on:	16,622,000 component test hours

Email Europe: KPD-Europe-sales@knowles.com | Asia: KPD-Asia-sales@knowles.com | USA: KPD-NA-sales@knowles.com

Packaging Information

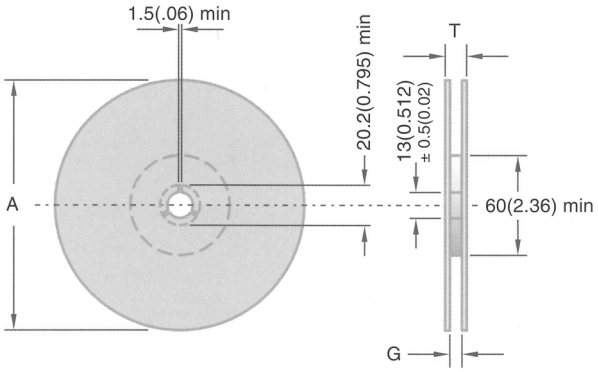
Tape and reel packing of surface mounting chip capacitors for automatic placement are in accordance with IEC60286-3.



Peel Force

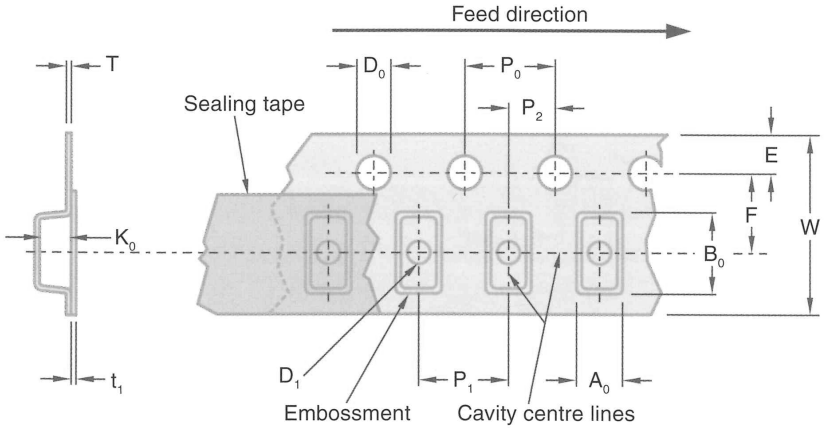
The peel force of the top sealing tape is between 0.2 and 1.0 Newton at 180º. The breaking force of the carrier and sealing tape in the direction of unreeling is greater than 10 Newtons.

Reel Dimensions



Symbol	Description	178mm Reel	330mm Reel
A	Reel diameter	178 (7)	330 (13)
G	Reel inside width	8.4 (0.33)	12.4 (0.49)
T	Reel outside width	14.4 (0.56) max	18.4 (0.72) max

Tape Dimensions



		Dimensions mm (inches)	
Symbol	**Description**	**8mm Tape**	**12mm Tape**
A_0 B_0 K_0	Width of cavity Length of cavity Depth of cavity	Dependent on chip size to minimize rotation	
W	Width of tape	8.0 (0.315)	12.0 (0.472)
F	Distance between drive hole centres and cavity centres	3.5 (0.138)	5.5 (0.213)
E	Distance between drive hole centres and tape edge	1.75 (0.069)	
P_1	Distance between cavity centres	4.0 (0.156)	8.0 (0.315)
P_2	Axial distance between drive hole centres and cavity centres	2.0 (0.079)	
P_0	Axial distance between drive hole centres	4.0 (0.156)	
D_0	Drive hole diameter	1.5 (0.059)	
D_1	Diameter of cavity piercing	1.0 (0.039)	1.5 (0.059)
XT	Carrier tape thickness	0.3 (0.012) ±0.1 (0.04)	0.4 (0.016) ±0.1 (0.04)
Xt_1	Top tape thickness	0.1 (0.004) max	

Packing Information

Missing Components

The number of missing components in the tape may not exceed 0.25% of the total quantity with not more than three consecutive components missing. This must be followed by at least six properly placed components

Identification

Each reel is labelled with the following information: manufacturer, chip size, capacitance, tolerance, rated voltage, dilectric type, batch number, date code and quantity of components.

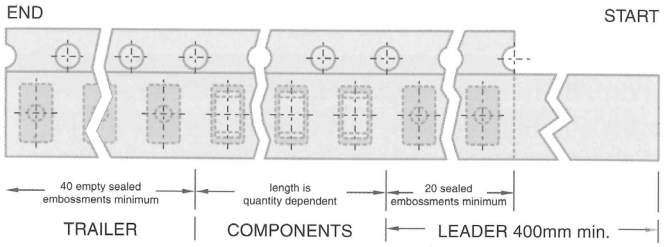
Component Orientation

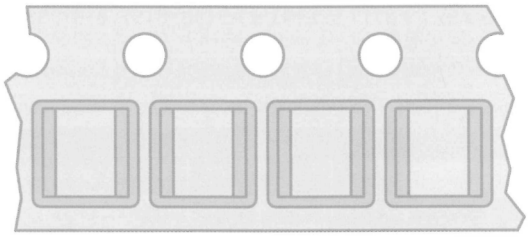
Tape and reeling is in accordance with IEC 60286 part 3, which defines the packaging specifications for leadless components on continuous tapes.

Notes: 1) IEC60286-3 states A0 <B0

2) Regarding the orientation of 1825 and 2225 components, the termination bands are right to left, NOT front to back. Please see diagram.

Leader Trailer



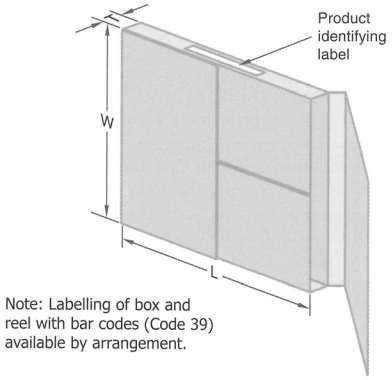


Orientation of 1825 & 2225 components

Outer Packaging

Outer carton dimensions mm (inches) max

Reel Size	No. of Reels	L	W	T
178 (7)	1	185 (7.28)	185 (7.28)	25 (0.98)
178 (7)	4	190 (7.48)	195 (7.76)	75 (2.95)
330 (13)	1	335 (13.19)	335 (13.19)	25 (0.98)



Note: Labelling of box and reel with bar codes (Code 39) available by arrangement.

Reel Quantities

Chip Size		0402	0505	0603	0805	1111	1206	1210	1210*	1410	1808	1812	1825	2211	2215	2220	2225
Max. Chip Thickness		0.5mm	1.3mm	0.8mm	1.3mm	2.0mm	1.6mm	2.0mm	6.0mm	2.0mm	2.0mm	2.5mm	2.5mm	2.5mm	2.5mm	2.5mm	2.5mm
		0.02”	0.05”	0.03”	0.05”	0.08”	0.06”	0.08”	0.24”	0.08”	0.08”	0.1”	0.1”	0.1”	0.1”	0.1”	0.1”
Reel Quantities	178mm (7”)	10000	2500	4000	3000	1000	2500	2000	300	2000	1500	500	500	750	500	500	500
	330mm (13”)	15000	10000	16000	12000	5000	10000	8000	1200	8000	6000	2000	2000	2000	2000	2000	2000

1210* VM2 parts only

Notes:

1) The above quantities per reel are for the maximum manufactured chip thickness. Thinner chips can be taped in larger quantities per reel.

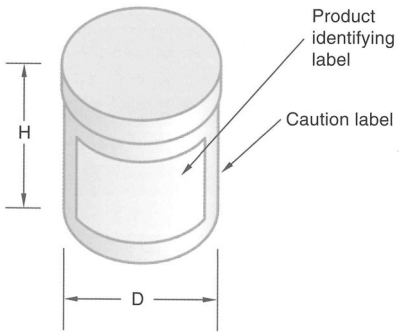
2) Where two different quantities are shown for the same case size, please contact the sales office to determine the exact quantity for any specific part number.

Bulk Packing – Tubs

Chips are supplied in rigid re-sealable plastic tubs together with impact cushioning wadding. Tubs are labelled with the details: chip size, capacitance, tolerance,rated voltage, dielectric type, batch number, date code and quantity of components.

Dimensions mm (inches)

H	60mm (2.36”)
D	50mm (1.97”)



Email Europe: KPD-Europe-sales@knowles.com | Asia: KPD-Asia-sales@knowles.com | USA: KPD-NA-sales@knowles.com